

**KEMET Part Number: C2225C123F2GACTU**  
(C2225C123F2GAC7800)

**KEMET**

a YAGEO company

SMD Comm COG, Ceramic, 0.012 uF, 1%, 200 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 2225



**Dimensions**

Chip Size	2225
L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
T	1.4mm +/-0.15mm
B	0.6mm +/-0.35mm

**Packaging Specifications**

<b>Packaging:</b>	T&R, 180mm, Plastic Tape
<b>Packaging Quantity:</b>	1000

**General Information**

<b>Series:</b>	SMD Comm COG
<b>Style:</b>	SMD Chip
<b>Description:</b>	SMD, MLCC, Ultra-Stable, Low Loss, Class I
<b>Features:</b>	Ultra-Stable, Low Loss, Class I
<b>RoHS:</b>	Yes
<b>Termination:</b>	Tin
<b>Marking:</b>	No
<b>AEC-Q200:</b>	No
<b>Component Weight:</b>	300 mg
<b>Shelf Life:</b>	78 Weeks
<b>MSL:</b>	1

**Specifications**

<b>Capacitance:</b>	0.012 uF
<b>Measurement Condition:</b>	1 kHz 1.0Vrms
<b>Capacitance Tolerance:</b>	1%
<b>Voltage DC:</b>	200 VDC
<b>Dielectric Withstanding Voltage:</b>	500 VDC
<b>Temperature Range:</b>	-55/+125°C
<b>Temperature Coefficient:</b>	COG
<b>Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):</b>	30 ppm/C, 1kHz 1.0Vrms
<b>Dissipation Factor:</b>	0.1% 1 kHz 1.0Vrms
<b>Aging Rate:</b>	0% Loss/Decade Hour
<b>Insulation Resistance:</b>	83.3333 GOhms

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